PATENT ASSIGNMENT

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 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hiroyasu SHICHI	03/31/2008
Satoshi TOMIMATSU	03/31/2008
Kaoru UMEMURA	03/28/2008
Noriyuki KANEOKA	03/28/2008
Koji ISHIGURO	03/28/2008

RECEIVING PARTY DATA

Name:	Hitachi High-Technologies Corporation	
Street Address:	1-24-14, Nishi Shinbashi, Minato-ku	
City:	Tokyo	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12108037

CORRESPONDENCE DATA

Fax Number: (703)684-1157

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 7036841120

Email: ncolston@msmbpatentlaw.com

Correspondent Name: Mattingly, Stanger, Malur & Brundidge, P.C.

Address Line 1: 1800 Diagonal Road

Address Line 2: Suite 370

Address Line 4: Alexandria, VIRGINIA 22314

ATTORNEY DOCKET NUMBER: POL-6357

NAME OF SUBMITTER: Nora Colston

Total Attachments: 1

PATENT REEL: 020898 FRAME: 0140

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PATENT REEL: 020898 FRAME: 0141

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan, located at 1-24-14, Nishi Shinbashi, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

ION SOURCE, ION BEAM PROCESSING/OBSERVATION APPARATUS, CHARGED PARTICLE BEAM APPARATUS, AND METHOD FOR OBSERVING CROSS SECTION OF SAMPLE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said

Hitachi High-Technologies Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation.

Signed on the date(s) indicated aside signatures:

	INVENTOR(S)	Date Signed
	(発明者フルネームサイン)	(署名日)
1)	Throyası Strichi Hiroyası SHICHI	3/31/2008
	Hiroyasu SHICHI V	
2)	Satoshi Tomimatsu	4/1/2008
	Kaon Cmenura Kaon Umenura	3/20/2008
	Moriyusi Kaneolea Noriyusi KANEOKA	3/28/2008
	Koji Shiguro	3/28/2008
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7)		
٥)		
8)		
9)		
10)		

PATENT REEL: 020898 FRAME: 0142

RECORDED: 05/05/2008